



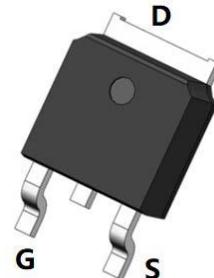
## SSCV4N650AGT8

N-Channel Enhancement Mode Power MOSFET

### ➤ Features

V <sub>DS</sub>	V <sub>GS</sub>	R <sub>DS(ON)</sub> Typ.	I <sub>D</sub>
650V	±30V	2.3Ω@10V	4A

### ➤ Pin Configuration



TO-252 (Top View)

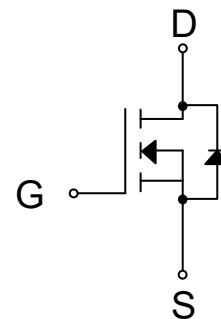
### ➤ Description

- This device is N-Channel enhancement MOSFET.
- Fast Switching.
- Improved dv/dt Capability.

**100% UIS + ΔVDS + Rg Tested!**

### ➤ Applications

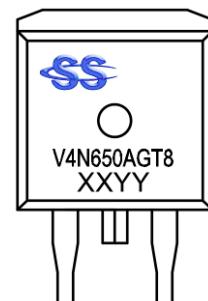
- Load Switch
- TV Power
- Uninterruptible Power Supply (UPS)



Pin Configuration

### ➤ Ordering Information

Device	Package	Shipping
SSCV4N650AGT8	TO-252	2500/Reel



Marking

(XXYY: Internal Traceability Code)

➤ Absolute Maximum Ratings ( $T_J=25^\circ\text{C}$  unless otherwise noted)

Symbol	Parameter	Ratings	Unit
$V_{DSS}$	Drain-to-Source Voltage	650	V
$V_{GSS}$	Gate-to-Source Voltage	$\pm 30$	V
$I_D$	Continuous Drain Current	$T_J=25^\circ\text{C}$	4
		$T_J=100^\circ\text{C}$	2.5
$I_{DM}$	Pulsed Drain Current <sup>a</sup>	16	A
$E_{AS}$	Single Pulsed Avalanche Energy	183	mJ
$P_D$	Power Dissipation, $T_J=25^\circ\text{C}$	35	W
$T_{STG} / T_J$	Junction & Storage Temperature Range	-55 to 150	$^\circ\text{C}$

➤ Thermal Resistance Ratings ( $T_J=25^\circ\text{C}$  unless otherwise noted)

Symbol	Parameter	Ratings	Unit
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient <sup>b</sup>	62	$^\circ\text{C}/\text{W}$
$R_{\theta JC}$	Thermal Resistance, Junction to Case	3.5	

Note:

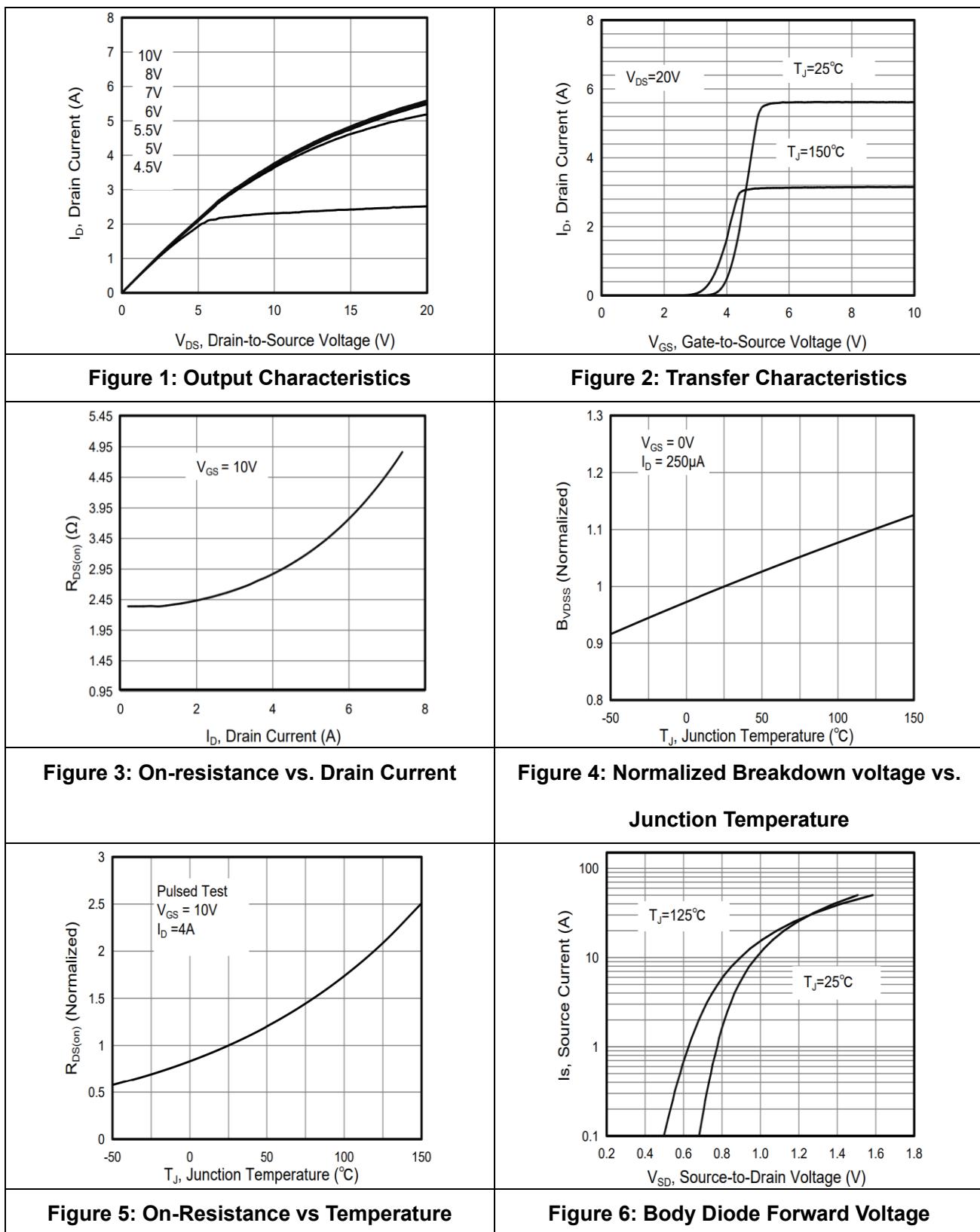
a. Repetitive Rating: Pulsed width limited by maximum junction temperature.

b.  $R_{\theta JA}$  is measured with the device mounted on a minimum recommended pad of 2oz copper FR4 PCB.

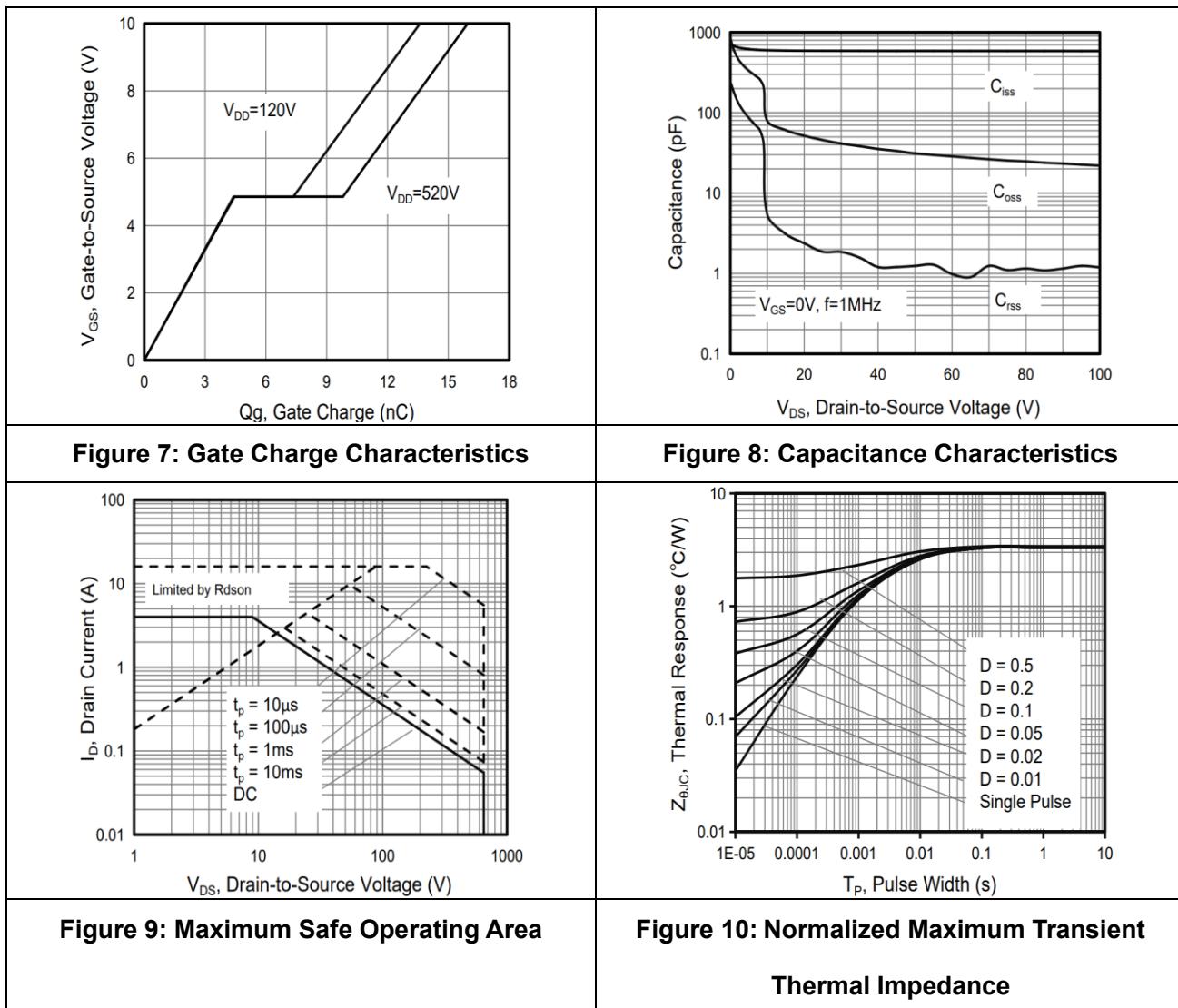
➤ Electrical Characteristics (T<sub>J</sub>=25°C unless otherwise noted)

Parameter	Symbol	Test Conditions	Min.	Typ.	Max.	Unit
Drain-Source Breakdown Voltage	V <sub>(BR)DSS</sub>	V <sub>GS</sub> = 0V, I <sub>D</sub> = 250μA	650			V
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> = 650V, V <sub>GS</sub> = 0V			1.0	μA
Gate-Source Leak Current	I <sub>GSS</sub>	V <sub>GS</sub> = ±30V, V <sub>DS</sub> = 0V			±100	nA
Gate Threshold Voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = 250uA	2	2.9	4	V
Drain-Source On-Resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = 10V, I <sub>D</sub> = 2A		2.3	2.75	Ω
Input Capacitance	C <sub>iss</sub>	V <sub>DS</sub> = 25V, V <sub>GS</sub> = 0V, f = 1MHz		589		pF
Output Capacitance	C <sub>oss</sub>			46		
Reverse Transfer Capacitance	C <sub>RSS</sub>			1.9		
Total Gate Charge	Q <sub>G</sub>	V <sub>GS</sub> = 0 to 10V, V <sub>DS</sub> = 520V, I <sub>D</sub> = 4A		16		nC
Gate to Source Charge	Q <sub>GS</sub>			4.5		
Gate to Drain Charge	Q <sub>GD</sub>			5.4		
Turn-on Delay Time	T <sub>D(ON)</sub>	V <sub>GS</sub> = 10V, V <sub>DS</sub> = 325V, I <sub>D</sub> = 4A, R <sub>G</sub> = 25Ω		11		ns
Rise Time	T <sub>r</sub>			25		
Turn-off Delay Time	T <sub>D(OFF)</sub>			25		
Fall Time	T <sub>f</sub>			16		
Drain to Source Diode Forward Voltage	V <sub>SD</sub>	V <sub>GS</sub> = 0V, I <sub>S</sub> = 4A			1.2	V
Body Diode Reverse Recovery Time	T <sub>rr</sub>	I <sub>F</sub> = 4A, di/dt = 100A/us		116		ns
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>			1.4		μC

➤ Typical Performance Characteristics ( $T_J=25^\circ\text{C}$  unless otherwise noted)

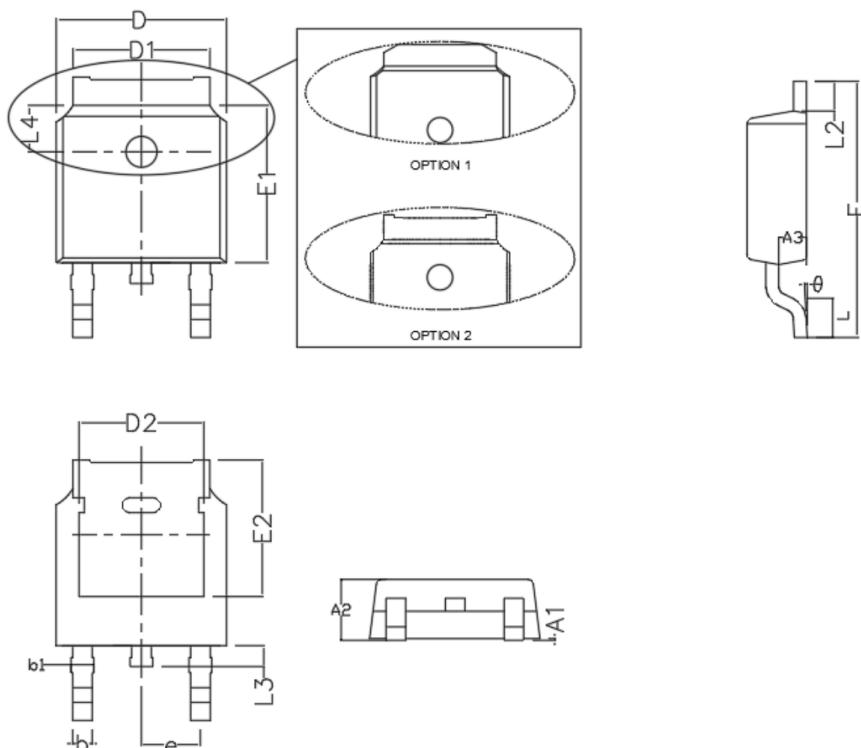


➤ Typical Performance Characteristics ( $T_J=25^\circ\text{C}$  unless otherwise noted)



➤ Package Information

TO252



Symbol	MILL IMETER			Symbol	MILL IMETER		
	Min	Nom	Max		Min	Nom	Max
A1	0.000	/	0.200	E1	5.800	6.100	6.400
A2	2.100	2.300	2.500	E2	5.100	5.450	5.600
A3	0.900	1.040	1.170	e	2.286TYP		
b	0.600	0.762	0.910	L	1.270	1.500	2.032
b1	0.680	0.840	1.145	L2	0.900	1.100	1.270
D	6.300	6.600	6.900	L3	0.600	0.800	1.000
D1	4.950	5.330	5.700	L4	1.600	1.800	2.000
D2	4.315	4.830	5.230	θ	0°	/	10°
E	9.395	10.100	10.700				



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